## Declaration'For U.S. Patent Application

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural

he specification o	f which is attached hereto unless the follo	wing is checked:		
•	was filed on	as Unite	ed States Application Number or	PCT Internation
	Application Number Num 2 7 2001	and was amended on		
	(if applicable).	1 .		
	I have reviewed and understand the conte	nts of the above-identified	specification, including the claim	m(s), as amende
acknowledge the	duty to disclose information which is mate	rial to patentability as defir	ned in Title 37, Code of Federal R	Regulations, § 1.
nventor's certifica	eign priority benefits under Title 35, Unite ate listed below and have also identified be at of the application on which priority is cl	elow any foreign application aimed:	on for patent or inventor's certifi	
(List prior	1999-349426	<u>Japan</u>	08/12/1999	_ O2 Yes □
foreign	(Number)	(Country)	(Day/Month/Year Filed)	_ Q Yes Q
applications. See note A	(Number)	(Country)	(Day/Month/Year Filed)	_ C Yes C
on back of this page)	(Number)	(Country)	(Day/Month/Year Filed)	_
	(Number)	(Country)	(Day/Month/Year Filed)	165
See note B on bac	ck of this page)	d list for additional prior f	foreign applications	
hereby claim the	benefit under Title 35, United States Code	c, § 119(e) of any United S	States provisional application(s)	listed below.
	(Application Number)		(Filing Date)	<del></del>
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ubject matter of e he first paragraph ty as defined in Ti	(Application Number) benefit under Title 35, United States Code ach of the claims of this application is not of Title 35, United States Code, § 112, I at the 37, Code of Federal Regulations, § 1.5	e, § 120 of any United State disclosed in the prior United to discharge the duty to discharge available	tes application(s) listed below an ited States application in the man isclose information which is mat	nner provided b erial to patental rior application

Trademark Office connected therewith:

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and/belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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